



# UC2802x Economy High-Speed PWM Controller

## 1 Features

- Peak Current Mode, Average Current Mode, or Voltage Mode (With FeedForward) Control Methods
- Practical Operation Up to 1 MHz
- 50-ns Propagation Delay to Output
- $\pm 1.5$ -A Peak Totem Pole Outputs
- 9-V to 30-V Nominal Operational Voltage
- Wide Bandwidth Error Amplifier
- Fully Latched Logic With Double Pulse Suppression
- Pulse-by-Pulse Current Limiting
- Programmable Maximum Duty Cycle Control
- Undervoltage Lockout With Hysteresis
- Trimmed 5.1-V Reference With UVLO
- Same Functionality as UC3823 and UC3825

## 2 Applications

- Off-Line and DC-DC Power Supplies
- Converters Using Voltage Mode, Peak Current Mode, or Average Current Mode Control Methods
- Single-Ended or Two-Switch Topology Designs

### 3 Description

The UC28023 and UC28025 are fixed-frequency PWM controllers optimized for high-frequency switched-mode power-supply applications. The UC28023 is a single output PWM for single-ended topologies while the UC28025 offers dual alternating outputs for double-ended and full bridge topologies.

Targeted for cost-effective solutions with minimal external components. UC2802x devices include an oscillator, a temperature compensated reference, a wide bandwidth error amplifier, a high-speed current-sense comparator, and high-current, active-high, totem-pole outputs to directly drive external MOSFETs.

Protection circuitry includes a current limit comparator with a 1-V threshold, a TTL compatible shutdown port, and a soft-start pin which doubles as a maximum duty-cycle clamp. The logic is fully latched to provide jitter-free operation and prohibit multiple pulses at an output. An undervoltage lockout section with 800 mV of hysteresis assures low start-up current. During undervoltage lockout, the outputs are high impedance. Propagation delays through the comparators and logic circuitry have been minimized while maximizing bandwidth and slew rate of the error amplifier.

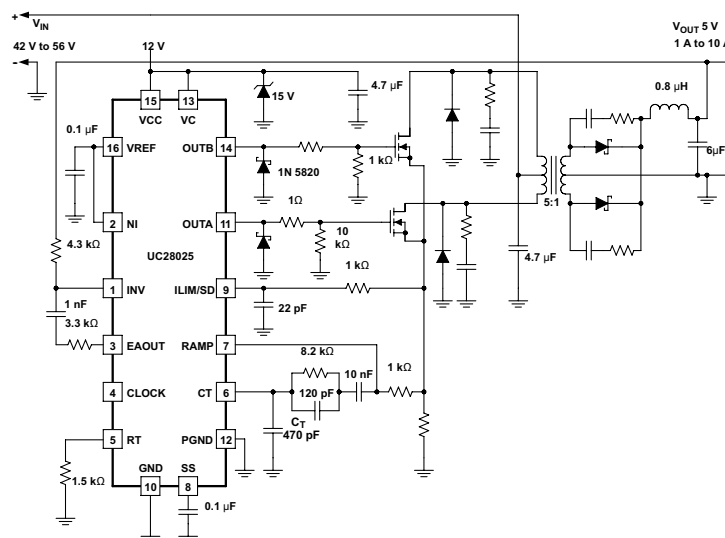
Devices are available in the industrial temperature range of  $-40^{\circ}\text{C}$  to  $105^{\circ}\text{C}$ . Package offerings are 16-pin SOIC (DW), or 16-pin PDIP (N) packages.

### Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)
UC2802x	SOIC (16)	10.30 mm x 7.50 mm
	PDIP (16)	19.30 mm x 6.35 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

## Typical Application Schematic



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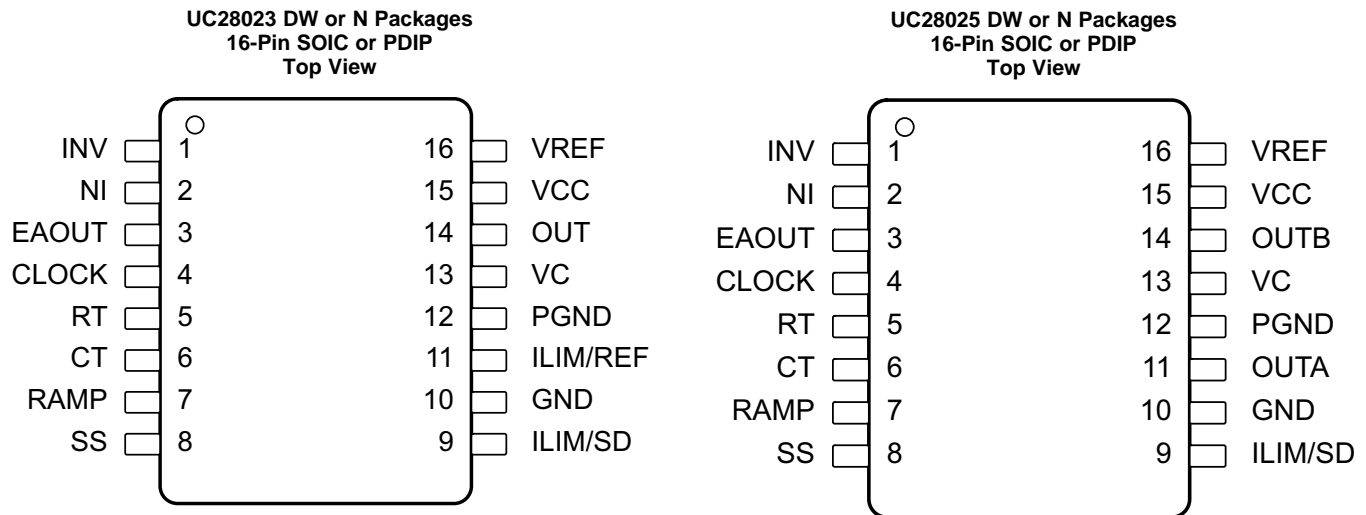
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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision F (August 2010) to Revision G	Page
• Added <i>Device Information</i> table, <i>Pin Configuration and Functions</i> section, <i>Specifications</i> section, <i>ESD Ratings</i> table, <i>Recommended Operating Conditions</i> table, <i>Switching Characteristics</i> table, <i>Typical Characteristics</i> section, <i>Detailed Description</i> section, <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section .....	<b>1</b>
• Deleted <i>Ordering Information</i> table; see POA at the end of the data sheet .....	<b>1</b>
• Moved Delay to output time parameters from <i>Electrical Characteristics</i> to <i>Switching Characteristics</i> .....	<b>1</b>
• Moved rise and fall time parameters from <i>Electrical Characteristics</i> to <i>Switching Characteristics</i> .....	<b>1</b>
• Deleted Lead temperature soldering rating in the <i>Absolute Maximum Ratings</i> table .....	<b>4</b>
• Added <i>Thermal Information</i> table .....	<b>4</b>
• Changed $R_{\theta JA}$ values for DW (SOIC) package From: 50°C/W to 100°C/W To: 70.5°C/W and for N (PDIP) package From: 90°C/W To: 44.5°C/W .....	<b>4</b>
• Changed $R_{\theta JC(top)}$ values for DW (SOIC) package From: 27°C/W To: 31.8°C/W and for N (PDIP) package From: 45°C/W To: 34.3°C/W .....	<b>4</b>

## 5 Pin Configuration and Functions



### Pin Functions

NAME	PIN		I/O	DESCRIPTION
	UC28023	UC28025		
CLOCK	4	4	O	Output of the internal oscillator
CT	6	6	I	Timing capacitor connection pin for oscillator frequency programming. The timing capacitor must be connected to the device ground using minimal trace length.
EAOUT	3	3	O	Output of the error amplifier for compensation
GND	10	10	—	Analog ground return pin.
ILIM/REF	11	—	I	Pin to set the current limit threshold externally.
ILIM/SD	9	9	I	Input to the current limit comparator and the shutdown comparator.
INV	1	1	I	Inverting input to the error amplifier
NI	2	2	I	Noninverting input to the error amplifier
OUT	14	—	O	High current totem pole output of the on-chip drive stage.
OUTA	—	11	O	High current totem pole output A of the on-chip drive stage.
OUTB	—	14	O	High current totem pole output B of the on-chip drive stage
PGND	12	12	—	Ground return pin for the output driver stage
RAMP	7	7	I	Noninverting input to the PWM comparator with 1.25-V internal input offset. In voltage mode operation this serves as the input voltage feedforward function by using the CT ramp. In peak current mode operation, this serves as the slope compensation input.
RT	5	5	I	Timing resistor connection pin for oscillator frequency programming
SS	8	8	I	Soft-start input pin.
VC	13	13	—	Power supply pin for the output stage. This pin must be bypassed with a 0.1-μF monolithic ceramic low ESL capacitor with minimal trace lengths.
VCC	15	15	—	Power supply pin for the device. This pin must be bypassed with a 0.1-μF monolithic ceramic low ESL capacitor with minimal trace lengths
VREF	16	16	O	5.1-V reference. For stability, the reference must be bypassed with a 0.1-μF monolithic ceramic low ESL capacitor and minimal trace length to the ground plane.

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)(2)</sup>

		MIN	MAX	UNIT
Input voltage	VC, VCC		30	V
Analog inputs	INV, NI, RAMP	−0.3	7	V
	SS, ILIM/SD	$V_{REF} - 0.3$	$V_{REF} + 0.3$	
$I_{OUT(DC)}$ Output current	OUT (UC28023), OUTB (UC28025)		±0.5	A
Peak output current, pulsed 0.5 ms ( $I_{OUT}$ pulsed)	OUT (UC28023), OUTB (UC28025)		±2	A
$I_{REF}$ Output current	VREF		10	mA
$I_{CLOCK}$ Output current	CLOCK		−5	mA
$I_{SINK\_SS}$ Soft-start sink current	SS		5	mA
$I_{OUT(EA)}$ Output current	EAOUT		20	mA
$I_{OSC\_CHG}$ Oscillator charging current	RT		−5	mA
$C_{LOAD}$ Capacitive load			200	pF
Power Dissipation at $T_A = 25^{\circ}\text{C}$ (all packages)			1	W
$T_J$ Operating junction temperature		−55	150	$^{\circ}\text{C}$
$T_{stg}$ Storage temperature		−65	150	$^{\circ}\text{C}$

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages are with respect to GND. All currents are positive into and negative out of the specified terminal.

### 6.2 ESD Ratings

		VALUE	UNIT
$V_{(ESD)}$ Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>	±3000	V
	Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup>	±1500	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

	MIN	NOM	MAX	UNIT
VCC input voltage from a low-impedance source		12		V
Operating temperature	−40		105	$^{\circ}\text{C}$

### 6.4 Thermal Information

THERMAL METRIC <sup>(1)</sup>		UC2802x		UNIT
		DW (SOIC)	N (PDIP)	
		16 PINS	16 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	70.5	44.5	$^{\circ}\text{C/W}$
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	31.8	34.3	$^{\circ}\text{C/W}$
$R_{\theta JB}$	Junction-to-board thermal resistance	35.2	24.6	$^{\circ}\text{C/W}$
$\Psi_{JT}$	Junction-to-top characterization parameter	7.7	14.7	$^{\circ}\text{C/W}$
$\Psi_{JB}$	Junction-to-board characterization parameter	34.7	24.4	$^{\circ}\text{C/W}$

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report.

## 6.5 Electrical Characteristics

 $T_A = -40^{\circ}\text{C}$  to  $105^{\circ}\text{C}$ ,  $T_J = T_A$ ,  $R_T = 3.65\text{ k}\Omega$ ,  $C_T = 1\text{ nF}$ ,  $V_{CC} = 15\text{ V}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>REFERENCE</b>						
$V_{REF}$	Reference voltage	$T_J = 25^{\circ}\text{C}$ , $I_{REF} = 1\text{ mA}$	5.05	5.1	5.15	V
	Line regulation voltage	$V_{CC} = 10\text{ V}$ to $30\text{ V}$		2	15	mV
	Load regulation voltage	$I_{REF} = 1\text{ mA}$ to $10\text{ mA}$		5	15	mV
	Temperature stability <sup>(1)</sup>	$T_A = -40^{\circ}\text{C}$ to $105^{\circ}\text{C}$		0.2	0.4	mV/ $^{\circ}\text{C}$
	Total output voltage variation <sup>(1)</sup>	Line and load temperature	4.95		5.25	V
	Output noise voltage <sup>(1)</sup>	$f = 10\text{ Hz}$ to $10\text{ kHz}$		50		$\mu\text{V}$
	Long-term stability voltage <sup>(1)</sup>	$T_J = 125^{\circ}\text{C}$ , 1000 hours		5	25	mV
$I_{SS}$	Short-circuit current	$V_{REF} = 0\text{ V}$	-20	-50	-100	mA
<b>OSCILLATOR</b>						
$f_{OSC}$	Initial accuracy <sup>(1)</sup>	$T_J = 25^{\circ}\text{C}$	360	400	440	kHz
	Voltage stability <sup>(1)</sup>	$V_{CC} = 10\text{ V}$ to $30\text{ V}$		0.2%	2%	
	Temperature stability <sup>(1)</sup>	$T_A = -40^{\circ}\text{C}$ to $105^{\circ}\text{C}$		5%		
	Total voltage variation <sup>(1)</sup>	Line temperature	340		460	kHz
$V_{CLOCK\_H}$	High-level clock output voltage		3.9	4.5		V
$V_{CLOCK\_L}$	Low-level clock output voltage			2.3	2.9	V
$V_{RAMP(P)}$	Ramp peak voltage <sup>(1)</sup>		2.6	2.8	3	V
$V_{RAMP(V)}$	Ramp valley voltage <sup>(1)</sup>		0.7	1	1.25	V
$V_{RAMP(VP)}$	Ramp valley-to-peak voltage <sup>(1)</sup>		1.6	1.8	2	V
<b>ERROR AMPLIFIER</b>						
$V_{IN}$	Input offset voltage				15	mV
$I_{BIAS}$	Input bias current			0.6	3	$\mu\text{A}$
$I_{IN}$	Input offset current			0.1	1	$\mu\text{A}$
$A_{VOL}$	Open-loop gain	$V_{OUT} = 1\text{ V}$ to $4\text{ V}$	60	95		dB
CMRR	Common-mode rejection ratio	$V_{CM} = 1.5\text{ V}$ to $5.5\text{ V}$	75	95		dB
PSRR	Power supply rejection ratio	$V_{CC} = 10\text{ V}$ to $30\text{ V}$	85	110		dB
$I_{OUT(SINK)}$	Output sink current	$V_{(EAOUT)} = 1\text{ V}$	1	2.5		mA
$I_{OUT(SRC)}$	Output source current	$V_{(EAOUT)} = 4\text{ V}$	-0.5	-1.3		mA
$V_{OH}$	High-level output voltage	$I_{(EAOUT)} = -0.5\text{ V}$	4	4.7	5	V
$V_{OL}$	Low-level output voltage	$I_{(EAOUT)} = 1\text{ mA}$	0	0.5	1	V
	Unity gain bandwidth <sup>(1)</sup>		3	5.5		MHz
	Slew rate <sup>(1)</sup>		6	12		V/ $\mu\text{s}$
<b>PWM COMPARATOR</b>						
$I_{BIAS\_RAMP}$	RAMP bias current	$V_{RAMP} = 0\text{ V}$		-1	-5	$\mu\text{A}$
Maximum duty cycle	UC28023		80%	90%		
	UC28025	See <sup>(2)</sup>	40%	45%		
Minimum duty cycle	UC28023				0%	
	UC28025				0%	
EAOUT zero DC threshold		$V_{RAMP} = 0\text{ V}$	1.1	1.25	1.4	V
<b>SOFT START</b>						
$I_{CHG}$	Charge current	$V_{SS} = 0.5\text{ V}$	3	9	20	$\mu\text{A}$
$I_{DISCHG}$	Discharge current	$V_{SS} = 1\text{ V}$	1	7.5		mA

(1) Specified by design. Not production tested.

(2) Tested as 80% minimum for the oscillator which is the equivalent of 40% for UC28025.

**UC28023, UC28025**

SLUS557G –MARCH 2003–REVISED DECEMBER 2016

[www.ti.com](http://www.ti.com)
**Electrical Characteristics (continued)**
 $T_A = -40^{\circ}\text{C}$  to  $105^{\circ}\text{C}$ ,  $T_J = T_A$ ,  $R_T = 3.65\text{ k}\Omega$ ,  $C_T = 1\text{ nF}$ ,  $V_{CC} = 15\text{ V}$  (unless otherwise noted)

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>CURRENT LIMIT AND SHUTDOWN</b>							
$I_{LIMIT}$	Current limit bias current		$V_{ILIM/SD} = 0\text{ V to }4\text{ V}$			$\pm 10$	$\mu\text{A}$
$I_{LIMIT}$	Offset voltage	UC28023				15	mV
$I_{LIMITREF}$	Common mode <sup>(1)</sup>	UC28023		1		1.25	V
	Current limit threshold voltage	UC28025		0.9	1	1.1	V
	Shutdown threshold voltage			1.25	1.4	1.55	V
<b>OUTPUT</b>							
$V_{OL}$	Low-level output voltage		$I_{OUT} = 20\text{ mA}$		0.25	0.4	V
			$I_{OUT} = 200\text{ mA}$		1.2	2.2	
$V_{OH}$	High-level output voltage		$I_{OUT} = -20\text{ mA}$	13	13.5		V
			$I_{OUT} = -200\text{ mA}$	12	13		
	Collector leakage		$V_C = 30\text{ V}$	100	500		$\mu\text{A}$
<b>UNDERVOLTAGE LOCKOUT (UVLO)</b>							
	Start threshold voltage			8.8	9.2	9.6	V
	Hysteresis			0.4	0.8	1.2	V
<b>SUPPLY CURRENT</b>							
	Start-up current		$V_{CC} = 8\text{ V}$		1.1	2	mA
$I_{CC}$	Operating current		$V_{INV} = V_{RAMP} = V_{ILIM} = 0\text{ V}$ , $V_{NI} = 1\text{ V}$		25	35	mA

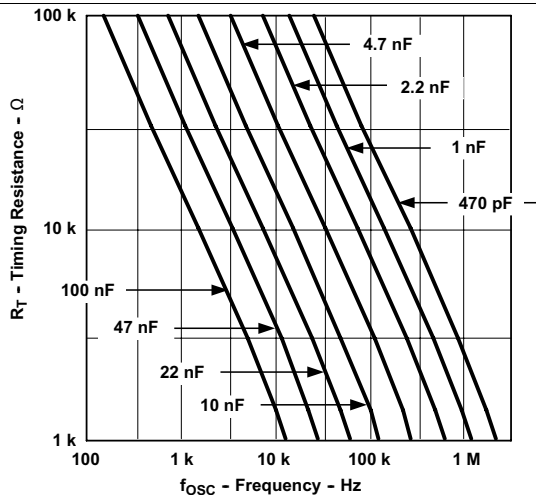
**6.6 Switching Characteristics**

over operating free-air temperature range (unless otherwise noted)

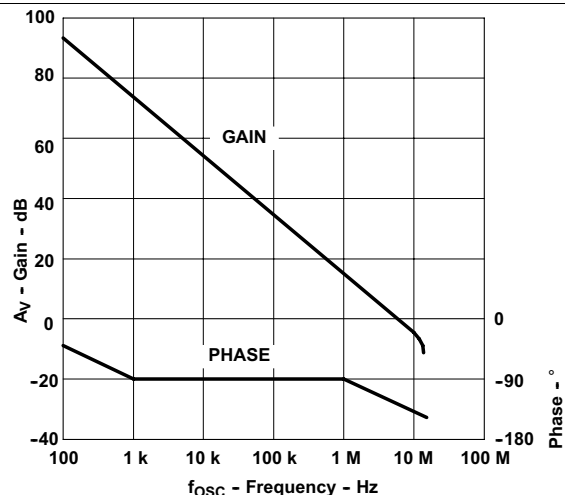
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{DELAY}$	Delay to output time <sup>(1)</sup>	PWM comparator		50	100	ns
		Current limit and shutdown		50	80	ns
	Rise time and Fall time <sup>(1)</sup>	$C_{LOAD} = 1\text{ nF}$	30	60		ns

(1) Specified by design. Not production tested.

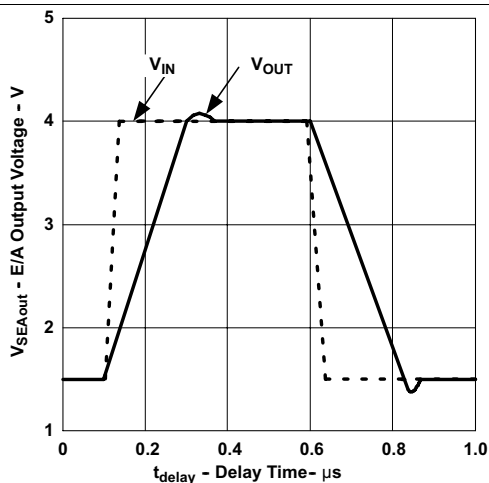
## 6.7 Typical Characteristics



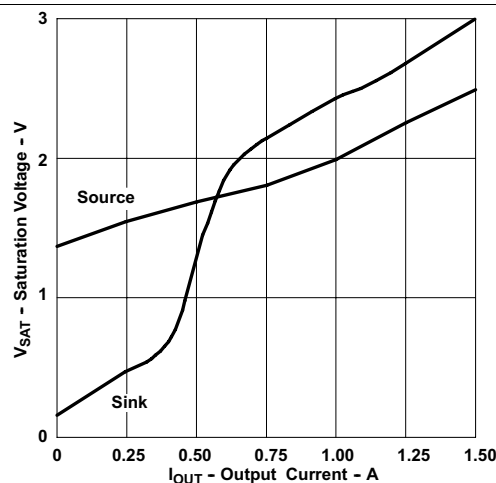
**Figure 1. Timing Resistance vs Frequency**



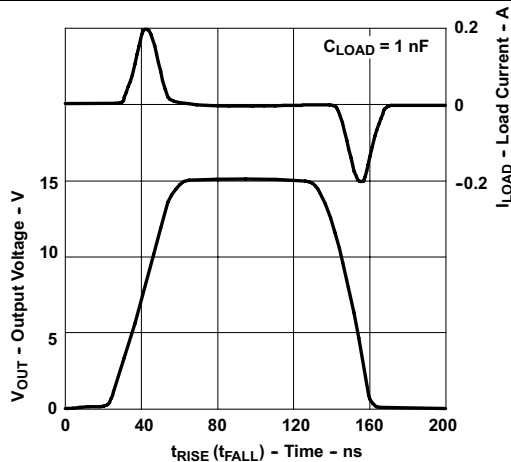
**Figure 2. Open-Loop Frequency Response**



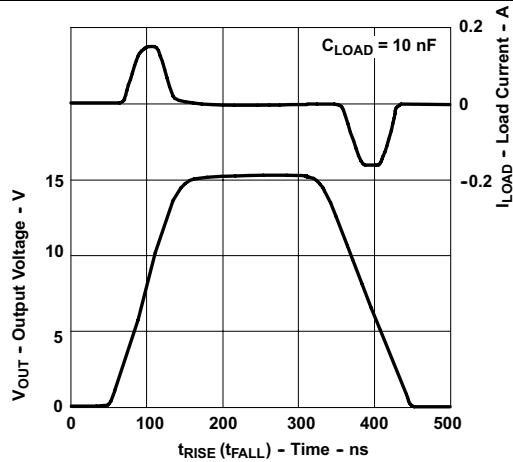
**Figure 3. Unity Gain Slew Rate**



**Figure 4. Saturation Voltage vs Output Current**



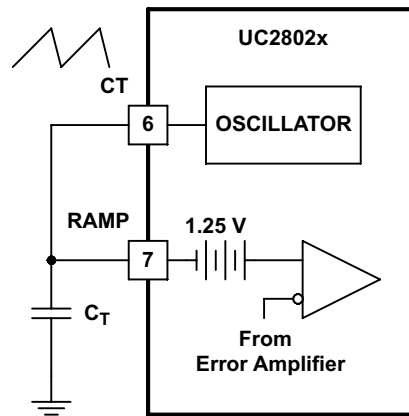
**Figure 5. Rise and Fall Time vs Output Voltage and Load Current**



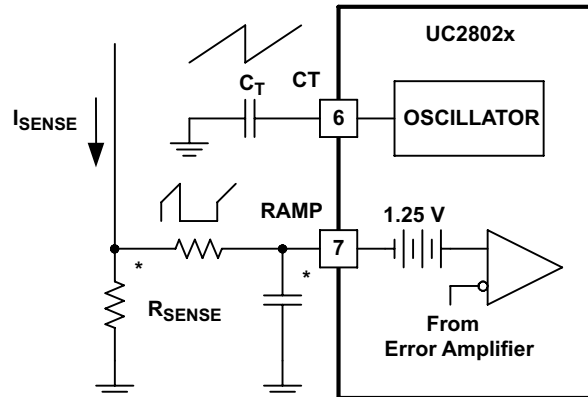
**Figure 6. Rise and Fall Time vs Output Voltage and Load Current**

## 7 Parameter Measurement Information

### 7.1 Control Methods and Test Circuits



**Figure 7. Voltage Mode Control**

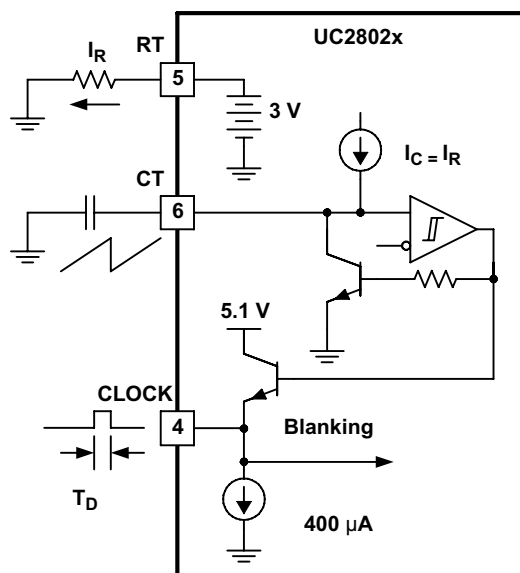


A small filter may be required to suppress switch noise.

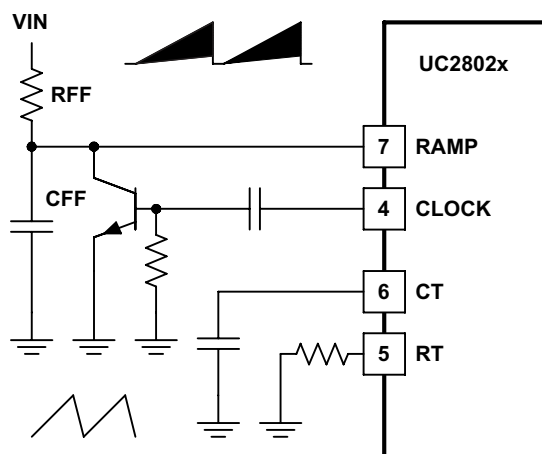
**Figure 8. Peak Current Mode Control**



## Control Methods and Test Circuits (continued)



**Figure 9. Oscillator Circuit**



**Figure 10. Feedforward Technique for Off-Line Voltage-Mode Applications**

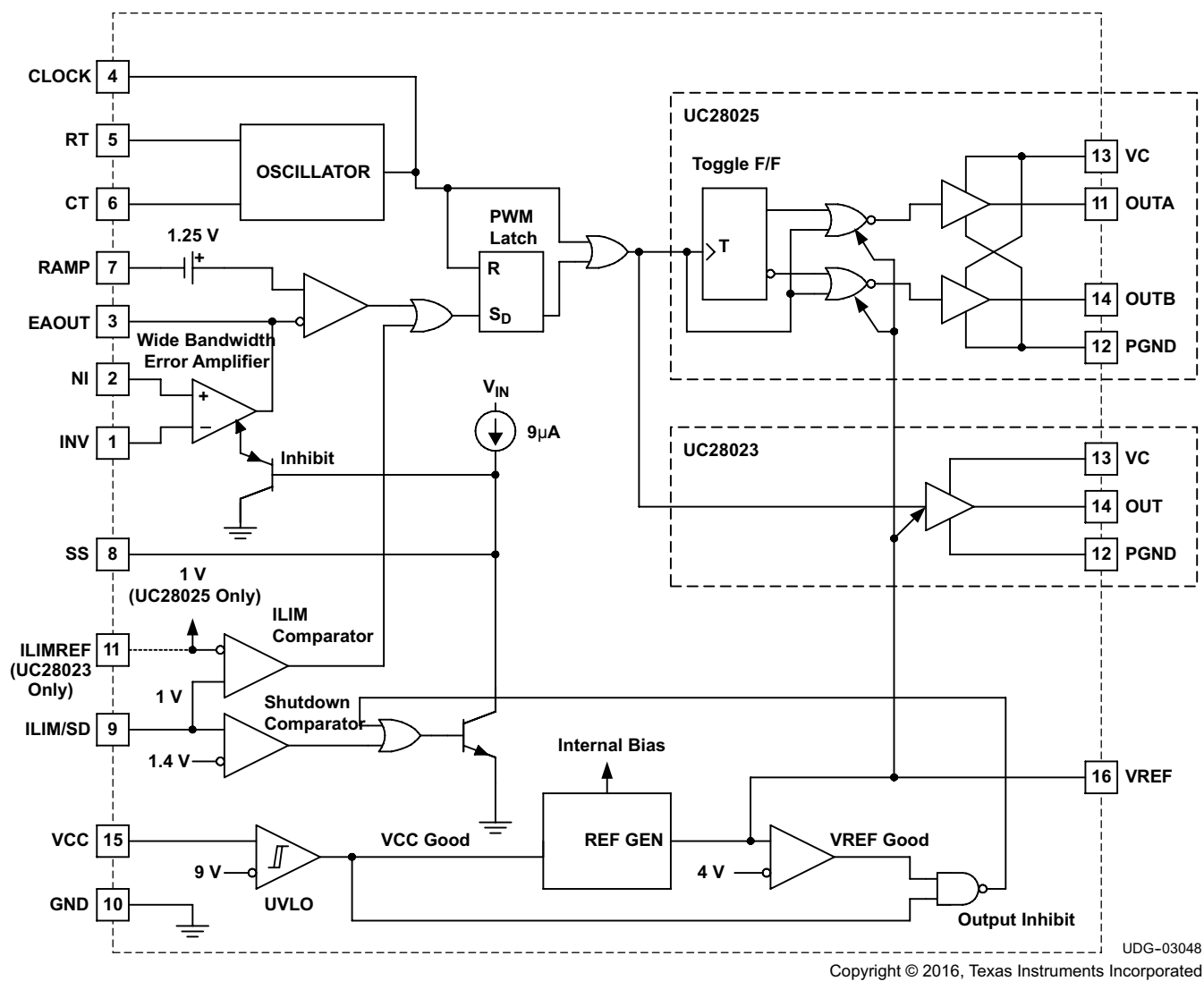
## 8 Detailed Description

### 8.1 Overview

The UC28023 and UC28025 (UC2802x) are fixed-frequency PWM controllers optimized for high-frequency switched-mode power-supply applications. Targeted for cost-effective solutions with minimal external components. UC2802x devices include an oscillator, a temperature-compensated reference, a wide band width error amplifier, a high-speed current-sense comparator, and high-current active-high totem-pole outputs to directly drive external MOSFETs.

Protection circuitry includes a current limit comparator with a 1-V threshold, a TTL compatible shutdown port, and a soft-start pin which doubles as a maximum duty cycle clamp. The logic is fully latched to provide jitter free operation and prohibit multiple pulses at an output. An undervoltage lockout section with 800 mV of hysteresis assures low start-up current. During undervoltage lockout, the outputs are high impedance. Propagation delays through the comparators and logic circuitry have been minimized while maximizing bandwidth and slew rate of the error amplifier.

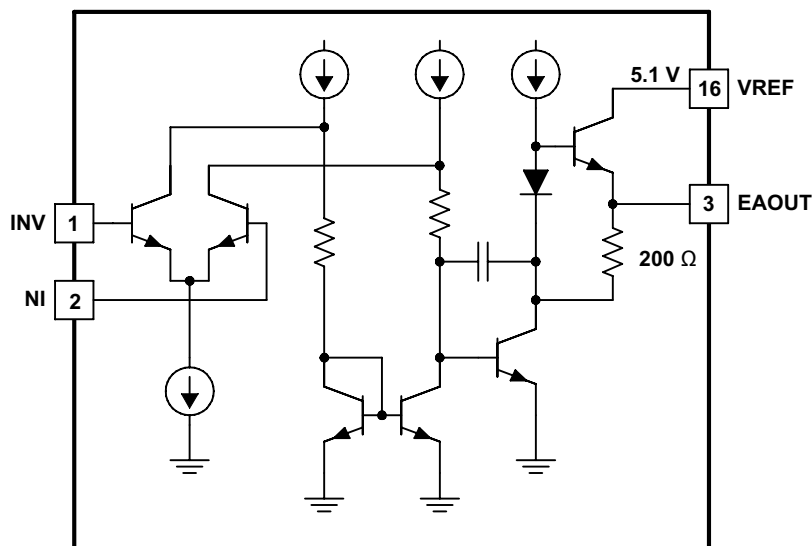
### 8.2 Functional Block Diagram



## 8.3 Feature Description

### 8.3.1 Error Amplifier

Figure 11 shows a simplified schematic of the UC2802x error amplifier and Figure 2 and Figure 3 show its characteristics.

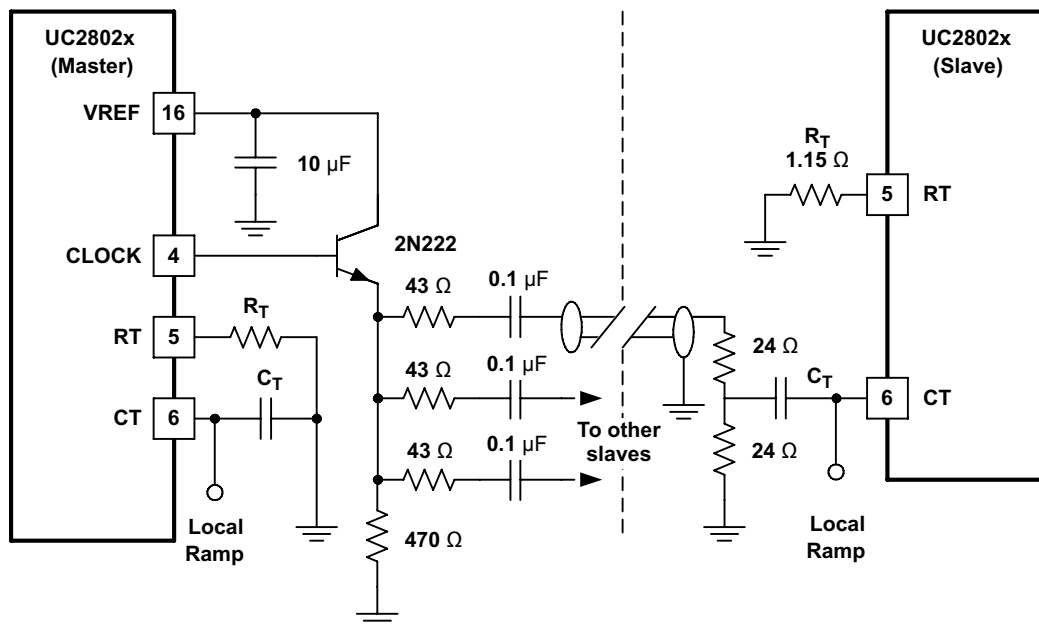


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Figure 11. Simplified Error Amplifier Schematic

### 8.3.2 Synchronization

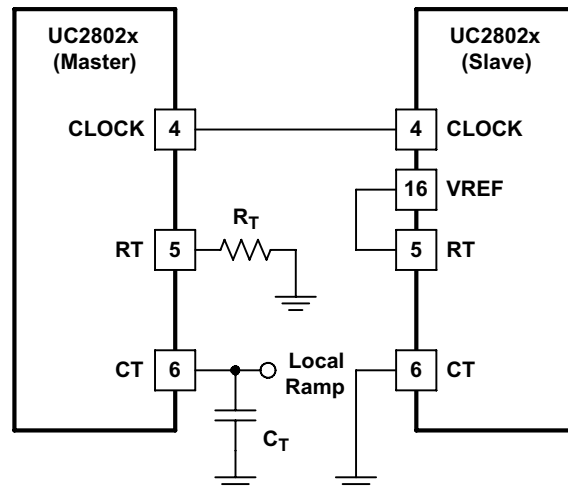
Figure 12 shows a generalized synchronization. Figure 13 shows a synchronized operation of two units in close proximity.



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Figure 12. Generalized Synchronization

## Feature Description (continued)

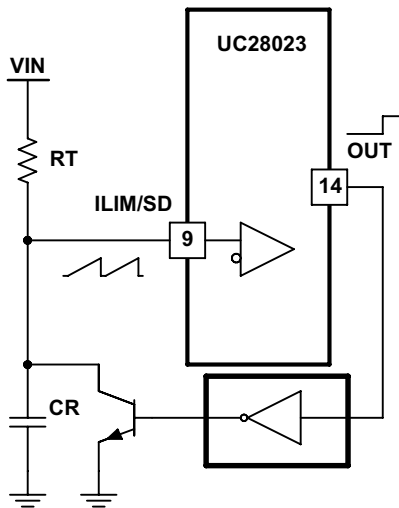


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**Figure 13. Synchronization of Two Units in Close Proximity**

### 8.3.3 Constant Volt-Second Clamp Circuit

The circuit for the UC28023 shown in Figure 14 describes achievement a constant volt-second product clamp over varying input voltages. The ramp generator components,  $R_T$  and  $C_R$  are chosen so that the ramp at Pin 9 (ILIM/SD) crosses the 1-V threshold at the same time the desired maximum volt-second product is reached. The delay through the functional inverter block must be such that the ramp capacitor can be completely discharged during the minimum deadtime.

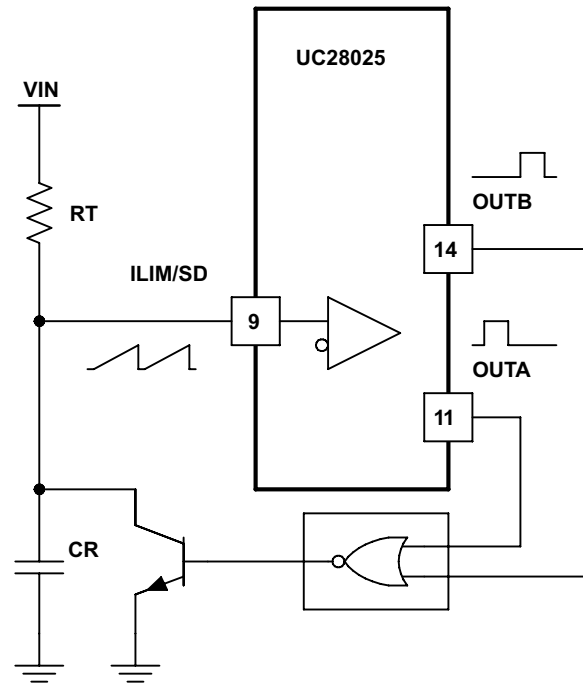


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**Figure 14. Achieving Constant Volt-Second Product Clamp With the UC28023**

The circuit for the UC28025 shown in Figure 15 describes achievement a constant volt-second product clamp over varying input voltages. The ramp generator components,  $R_T$  and  $C_R$  are chosen so that the ramp at Pin 9 (ILIM/SD) crosses the 1-V threshold at the same time the desired maximum volt-second product is reached. The delay through the functional inverter block must be such that the ramp capacitor can be completely discharged during the minimum deadtime.

## Feature Description (continued)

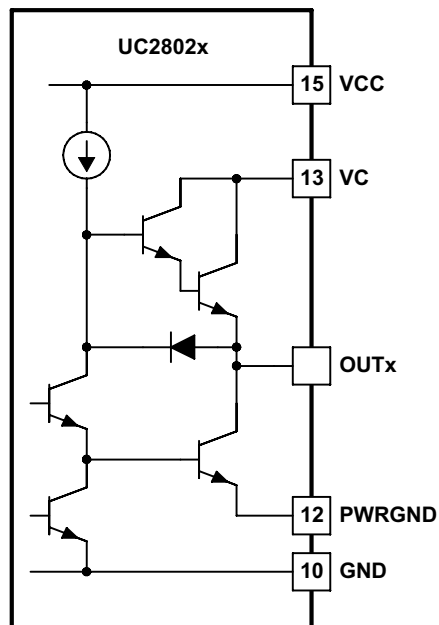


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**Figure 15. Achieving Constant Volt-Second Product Clamp With the UC28025**

### 8.3.4 Outputs

UC28023 has one output and UC28025 has dual alternating outputs.



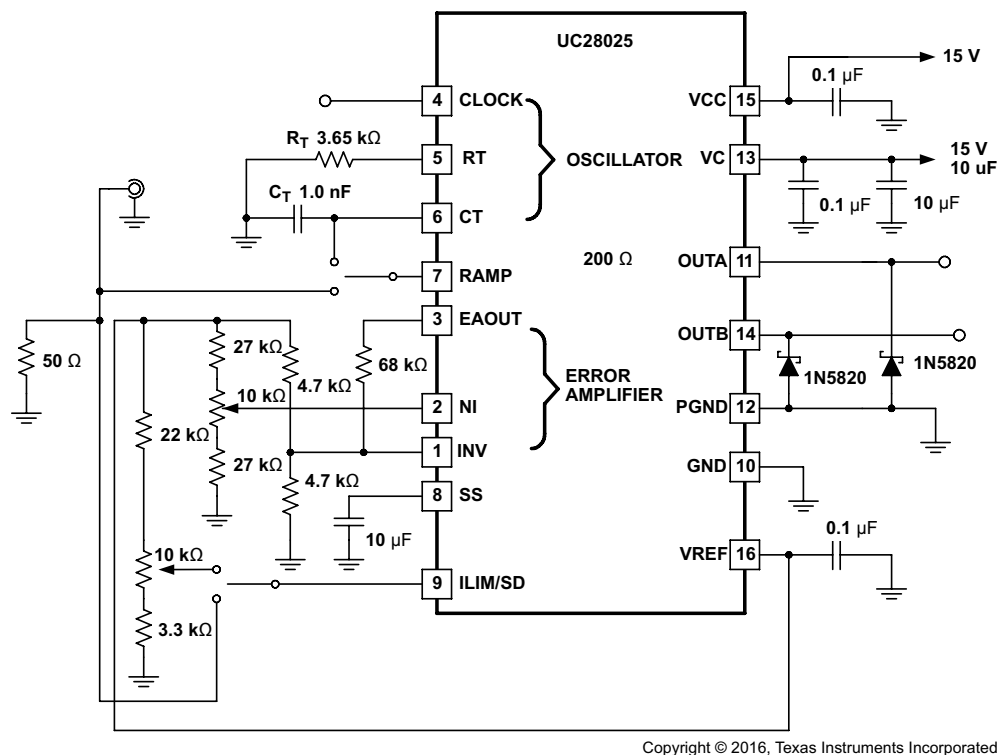
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**Figure 16. Simplified Schematic**

## Feature Description (continued)

### 8.3.5 Open-Loop Laboratory Test Fixture

The following test fixture is useful for exercising many of the UC28025's functions and measuring their specifications. As with any wideband circuit, careful ground and bypass procedures must be followed. TI highly recommends using a ground plane



**Figure 17. Laboratory Test Fixture**

### 8.4 Device Functional Modes

There are no functional modes for this device.



## Typical Application (continued)

### 9.2.1 Design Requirements

For this design example, use the parameters listed in [Table 1](#) as the input parameters.

**Table 1. Design Parameters**

PARAMETER	EXAMPLE VALUE
Input voltage	42 V to 56 V (48-V typical)
Output voltage	5 V
Output current	1 A to 10 A
Oscillator frequency	1.5 MHz
Switching frequency	750 kHz
Timing resistance	1.5 kΩ
Timing capacitance	470 pF

### 9.2.2 Detailed Design Procedure

#### 9.2.2.1 Timing Resistor and Capacitor Selection

Generally, a higher switching frequency results in a smaller size but has higher switching losses. Operation at 750 kHz is used in this example as a reasonable compromise between size and efficiency. The values for timing resistance ( $R_T$ ) and timing capacitance ( $C_T$ ) are selected for the 1.5-MHz oscillator based on [Figure 1](#).

#### 9.2.2.2 Turns Ratio Selection

The maximum primary-to-secondary turns ratio ( $N_{MAX}$ ) can be determined with the target output voltage, minimum input voltage, and the estimated maximum duty cycle.  $D_{LIM} = 0.35$  is used for this example.  $N_{MAX}$  can be calculated using [Equation 1](#).

$$N_{MAX} = \frac{2 \times D_{LIM} \times V_{INMIN}}{V_{OUT} + V_F} = \frac{2 \times 0.35 \times 42 \text{ V}}{5 \text{ V} + 0.3 \text{ V}} = 5.55 \quad (1)$$

Rounding  $N_{MAX}$  down to the next lowest integer results in a turns ratio of  $N = 5$ .

#### 9.2.2.3 Inductor Selection

The maximum inductor ripple current occurs at the maximum input voltage. Typically, 20% to 40% of the full load current ripple is a good compromise between core loss and copper loss of the inductor. Higher ripple current allows for smaller inductor size, but places more burden on the output capacitor to smooth the ripple voltage on the output. In this example a ripple current of 25% of 10 A is used. The inductor value can be calculated with [Equation 2](#).

$$L_O = \frac{V_{OUT} + V_F}{\Delta I_L \times f_{SW}} \times \left( \frac{1}{2} - \frac{N \times (V_{OUT} + V_F)}{2 \times V_{INMAX}} \right) = 0.745 \mu\text{H} \quad (2)$$

The closest standard value of 0.8  $\mu\text{H}$  is chosen for  $L_O$ , this step is necessary if the chosen  $L_O$  differs significantly from the value calculated in [Equation 2](#). The actual  $\Delta I_L$  is based upon this selected inductor which must be calculated with [Equation 3](#).

$$\Delta I_L = \frac{V_{OUT} + V_F}{L_O \times f_{SW}} \times \left( \frac{1}{2} - \frac{N \times (V_{OUT} + V_F)}{2 \times V_{INMAX}} \right) = 2.327 \text{ A} \quad (3)$$

#### 9.2.2.4 Rectifier Diode Selection

A rectifier diode must always possess low-forward voltage drop. When used in high-frequency switching applications, however, the diode must also possess a short recovery time. Schottky diodes meet both requirements and TI recommends their use for push-pull converter designs.



### 9.2.2.5 Snubber Components Selection

A resistor-capacitor snubber network crossing the low-side MOSFET reduces ringing and spikes at the switching node. Excessive ringing and spikes can cause erratic operation and may couple noise to the output voltage. Selecting the values for the snubber is best accomplished through empirical methods. First, make sure the lead lengths for the snubber connections are very short. Start with a resistor value between  $5\ \Omega$  and  $50\ \Omega$ . Increasing the value of the snubber capacitor results in more damping, but higher snubber losses. Select a minimum value for the snubber capacitor that provides adequate damping of the spikes on the switch node waveform at heavy load. A snubber may not be necessary with an optimized layout.

### 9.2.2.6 VCC and VC Capacitor Selection

The primary purpose of the VCC and VC capacitor is to supply the peak transient currents of the drivers as well as provide stability for the VCC and VC regulator. These peak currents can be several amperes. The value of the VCC and VC capacitor must at least  $0.47\ \mu\text{F}$ , and must be a good quality, low ESR, ceramic capacitor. The VCC and VC capacitor must be placed at the pins of the IC to minimize potentially damaging voltage transients caused by trace inductance. A value of  $4.7\ \mu\text{F}$  is used in this design.

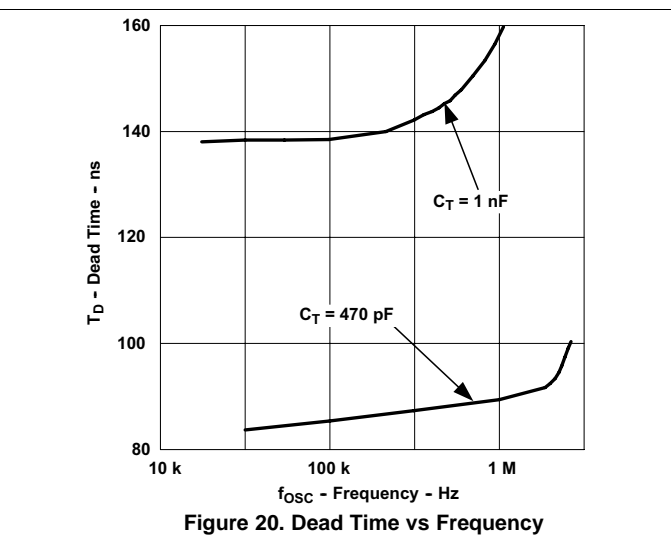
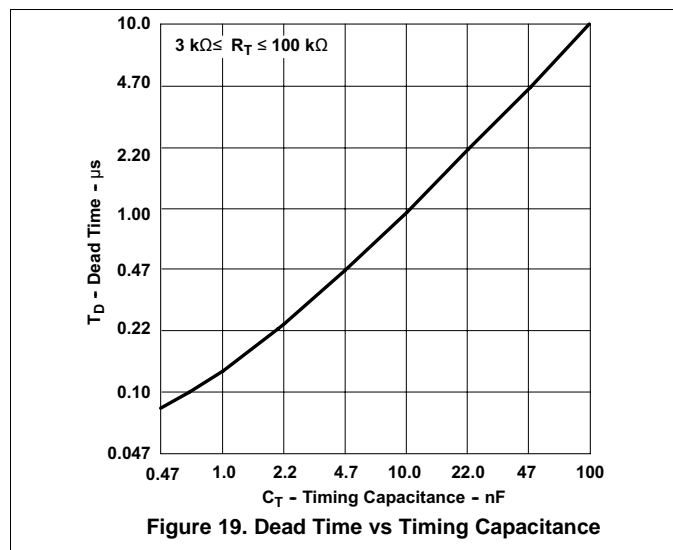
### 9.2.2.7 Output Capacitor Selection

The output capacitors smooth the output voltage ripple caused by inductor ripple current and provide a source of charge during load transient conditions. In this design example, a  $6\text{-}\mu\text{F}$  capacitor is selected as the main output capacitor.

### 9.2.2.8 Input Capacitor Selection

The input supply voltage typically has high source impedance at the switching frequency. Good quality input capacitors are necessary to limit the ripple voltage at the VIN pin while supplying most of the switch current during the on-time. The input capacitor must be selected for RMS current rating and minimum ripple voltage. In this example, a  $4.7\text{-}\mu\text{F}$  capacitor is used. With ceramic capacitors, the input ripple voltage is triangular.

## 9.2.3 Application Curves



## 10 Power Supply Recommendations

The UC28023 and UC28025 operate from an external bias supply. TI recommends powering the device from a regulated auxiliary supply. (This device is not intended to be used from a bootstrap bias supply. A bootstrap bias supply is fed from the input high voltage through a resistor with sufficient capacitance on VCC to hold up the voltage on VCC until current can be supplied from a bias winding on the boost inductor. For that reason, the minimal hysteresis on VCC would require an unreasonable value of hold-up capacitance.)

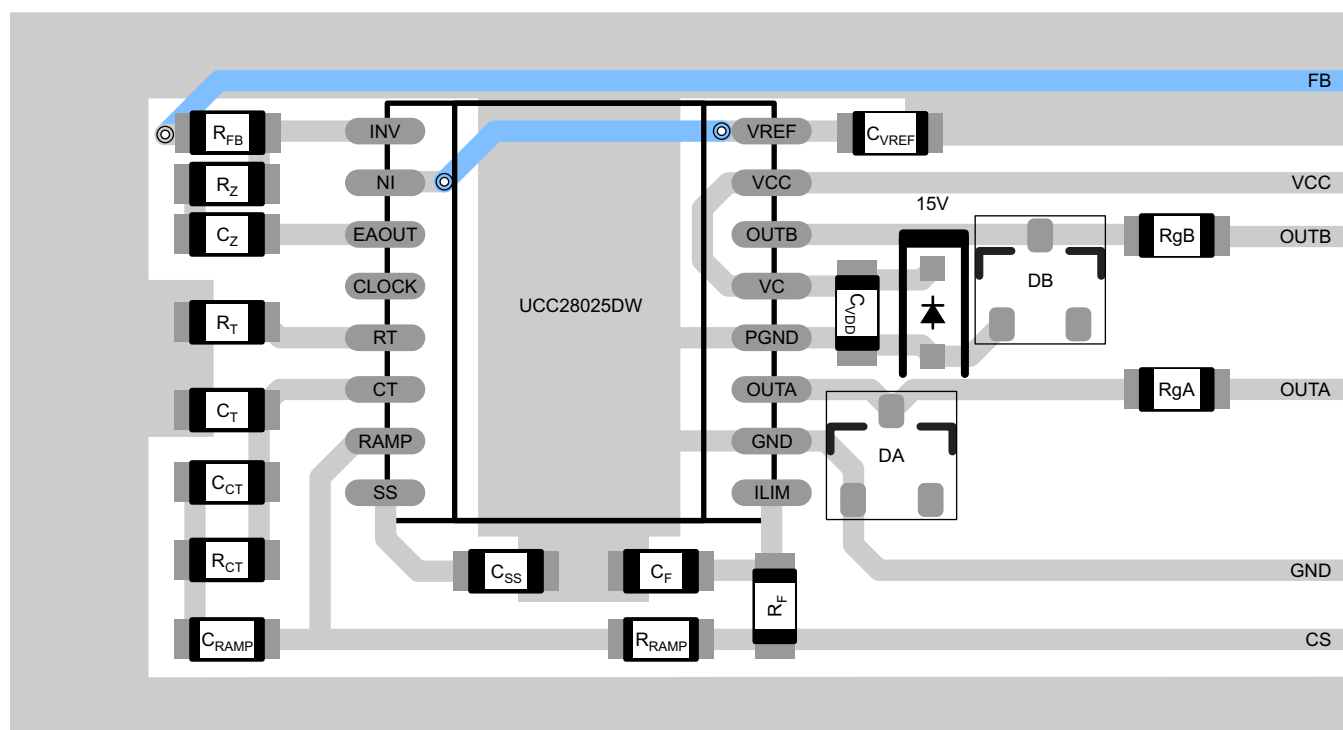
## 11 Layout

### 11.1 Layout Guidelines

High speed circuits demand careful attention to layout and component placement. To assure proper performance of the UC2802x follow these rules:

1. Use a ground plane.
2. Damp or clamp parasitic inductive kick energy from the gate of driven MOSFETs. Do not allow the output pins to ring below ground. A series gate resistor or a shunt 1-A Schottky diode at the output pin serves this purpose.
3. Bypass VCC, VC, and VREF. Use 0.1- $\mu$ F monolithic ceramic capacitors with low equivalent series inductance. Allow less than 1 cm of total lead length for each capacitor between the bypassed pin and the ground plane.
4. Treat the timing capacitor ( $C_T$ ) as a bypass capacitor.

### 11.2 Layout Example



**Figure 21. Layout Recommendation**

## 12 Device and Documentation Support

### 12.1 Documentation Support

#### 12.1.1 Related Documentation

For related documentation see the following:

- [1.5-MHz Current Mode IC Controlled 50--Watt Power Supply](#) (SLUA053)
- [The UC3823A,B and UC3825A,B Enhanced Generation of PWM Controllers](#) (SLUA125)

### 12.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 2. Related Links**

PARTS	PRODUCT FOLDER	SAMPLE & BUY	TECHNICAL DOCUMENTS	TOOLS & SOFTWARE	SUPPORT & COMMUNITY
UC28023	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>
UC28025	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>

### 12.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 12.4 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 12.5 Trademarks

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### 12.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 12.7 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">UC28023DW</a>	Active	Production	SOIC (DW)   16	40   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 105	UC28023DW
UC28023DW.A	Active	Production	SOIC (DW)   16	40   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 105	UC28023DW
<a href="#">UC28023DWR</a>	Active	Production	SOIC (DW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 105	UC28023DW
UC28023DWR.A	Active	Production	SOIC (DW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 105	UC28023DW
<a href="#">UC28025DW</a>	Active	Production	SOIC (DW)   16	40   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 105	UC28025DW
UC28025DW.A	Active	Production	SOIC (DW)   16	40   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 105	UC28025DW
UC28025DWG4	Active	Production	SOIC (DW)   16	40   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 105	UC28025DW
<a href="#">UC28025DWR</a>	Active	Production	SOIC (DW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 105	UC28025DW
UC28025DWR.A	Active	Production	SOIC (DW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 105	UC28025DW
<a href="#">UC28025N</a>	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 105	UC28025N
UC28025N.A	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 105	UC28025N
UC28025NG4	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 105	UC28025N

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UC28023DWR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1
UC28025DWR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UC28023DWR	SOIC	DW	16	2000	353.0	353.0	32.0
UC28025DWR	SOIC	DW	16	2000	353.0	353.0	32.0

## TUBE



\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
UC28023DW	DW	SOIC	16	40	507	12.83	5080	6.6
UC28023DW.A	DW	SOIC	16	40	507	12.83	5080	6.6
UC28025DW	DW	SOIC	16	40	507	12.83	5080	6.6
UC28025DW.A	DW	SOIC	16	40	507	12.83	5080	6.6
UC28025DWG4	DW	SOIC	16	40	507	12.83	5080	6.6
UC28025N	N	PDIP	16	25	506	13.97	11230	4.32
UC28025N.A	N	PDIP	16	25	506	13.97	11230	4.32
UC28025NG4	N	PDIP	16	25	506	13.97	11230	4.32



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